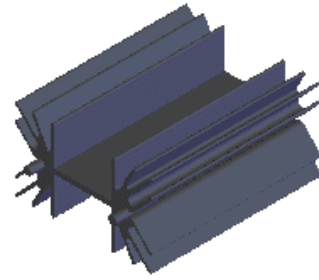


Product- information Type: PR33/50,8/SE

Group: Special heatsinks, Finger shaped heatsinks

Special heatsinks

| | |
|------------------------------|-------------------|
| Application (Cases): | TO220 TO218(TOP3) |
| Number of semiconductors: | 1 |
| Mounting of semiconductors : | to screw |
| Mounting of heatsinks: | to solder |
| Finish: | black anodized |
| Thermal resistance: | 4.2 K/W |
| Material: | Aluminium |



Special extruded heatsink for semiconductor case TO220; TO218(TOP3).

Standard heights: 25,4, 38,1, 50,8 and 63,5 mm.

Version MC (Mounting clip) for clip mounting of semiconductor.

Heatsink solderable by tin plated solder pins.

Also available with distance-/insulating rings, add. IR to the type no.

